

WAI 2026

Hangzhou, China

November 4 – 6, 2026



2026 International Workshop on
Advanced Interconnects
Hangzhou, China

WAI 2026

November 4 – 6, 2026

Agenda



浙江大学
ZHEJIANG UNIVERSITY



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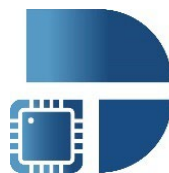
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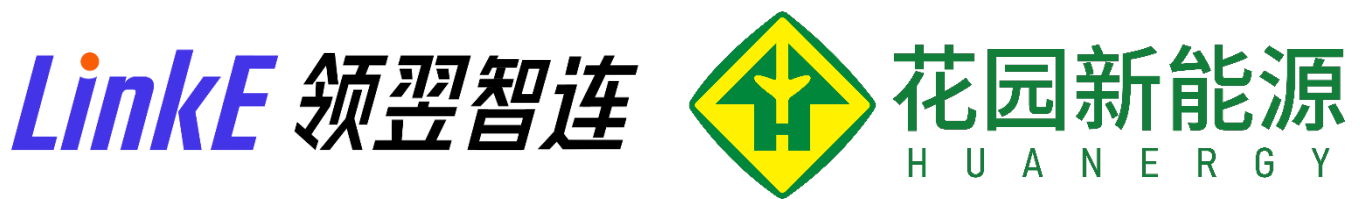


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The Organizers of WAI 2026 gratefully acknowledge
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IEEE WAI 2026 welcomes sponsors and exhibitors from interested companies and institutions.

We have created a good set of sponsorship opportunity packages designed to suit all your needs. Each allows you to showcase your products and services where the top marketing decision-makers and influencers network.

Please contact our staff for more information:

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Email: conference@detooltech.com

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INVITATION FROM THE GENERAL CHAIR

Dear Colleagues and Friends,

On behalf of the 2026 WAI Steering Committee, we are privileged and honored to invite you, your colleagues and families to join us for the third International Workshop on Advanced Interconnects (WAI) from Wednesday, Nov. 4th to Friday, Nov. 6th in Hangzhou, China.

The IEEE International Workshop on Advanced Interconnects is a newly launched IEEE event. The scope of this workshop specially addresses the latest development and innovations in the advanced interconnects field. The topics include but are not limited to: advanced interconnects and packaging, signal and power integrity, electromagnetic interference and compatibility (EMI/EMC), electrostatic discharge (ESD) and reliability, multiphysics integrity, modeling, simulation, and design methodologies, AI and intelligent EDA technologies, measurement, testing, and validation, as well as RF, microwave, antennas, and emerging applications and systems.

The IEEE EMC Society is the primary co-sponsor of this event, in collaboration with DeToolIC, Zhejiang University, Zhejiang University-University of Illinois Urbana-Champaign Institute, and China University of Petroleum.

We warmly welcome you to join us in Hangzhou in November of 2026 for an outstanding scientific/technical event and an unforgettable experience for you and your family.

WAI 2026 General Chairs



Er-Ping Li, IEEE Fellow

Qiuhsi Chair Professor, Zhejiang University



Jun Fan, IEEE Fellow

Qiushi Professor, Zhejiang University

CHAIRS FOR TECHNICAL PROGRAM COMMITTEE

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Zhejiang University

Co-Chairs of the Technical Program Committee



Hanzhi Ma
Zhejiang University



Bo Pu
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Xiaoning Ye
VP Technical Services, EMC Society

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Astronautics, China



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Da Li, Zhejiang
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Program Chair

Yan Li, China Jiliang
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Publication Chair

Jiefeng Zhou, Nanjing
University of
Aeronautics and
Astronautics, China



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Qiusen He,
DetoolTech Ltd,
China



GENERAL INFORMATION

REGISTRATION

Registration link:

please register an account at <https://wai-emc.com/wai2026/registration>.

Each participant or each presenting author must pay a non-refundable pre-registration fee. **Only pre-registered and paid submissions before 26 October, 2026 will be scheduled in the symposium program.** Inclusion of the submissions in the final Technical Program (one-page abstracts only), and WAI Proceedings (one-page abstracts only) is guaranteed only after the pre-registration of the presenting author is completed.

Your pre-registration will be valid only provided the payment is received timely. The pre-registration deadline is 26 October, 2026. The on-site registration opportunity is for non-presenting authors only. The registration fee for your articles is non-refundable. The registration fee is the same for presenting authors and non-presenting authors.

One registration fee can cover a maximum of two papers. Registration includes daily tea break, lunches and dinners from November 4-5.

Onsite Participants	Registration Fee
Student Full Price Ticket	USD 208 / RMB 1480
Regular Full Price Ticket	USD 348 / RMB 2480

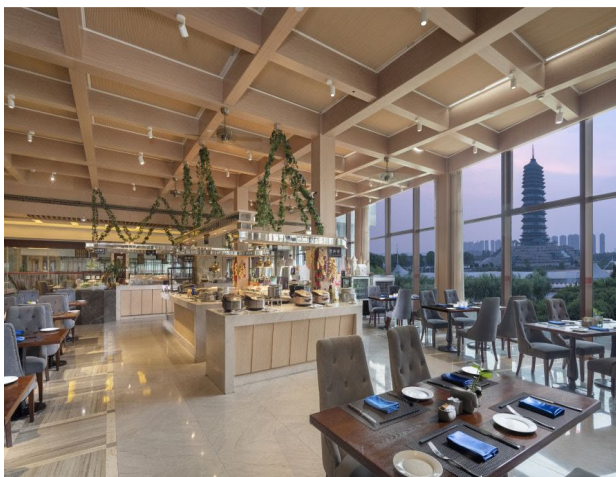
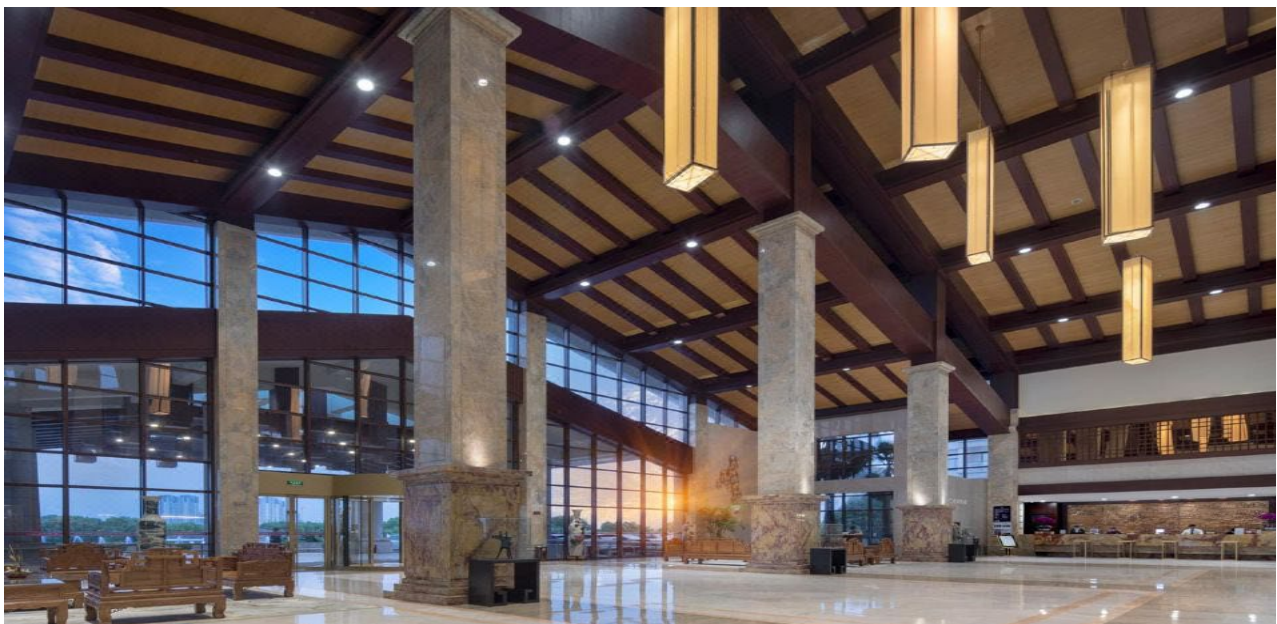
CONFERENCE VENUE

Hangzhou Blossom Water Museum Hotel

Hangzhou Blossom Water Museum Hotel is located on the banks of the world-renowned Qiantang River, within the China Water Museum Park in Hangzhou. The hotel is approximately 30 minutes from West Lake and only a short drive from Hangzhou Xiaoshan International Airport.

Surrounded by lush greenery, tranquil lakes, and the magnificent Qiantang River, the hotel provides a unique combination of river views, lake views, and garden landscapes. Covering an area of approximately 112 acres, the hotel has been carefully designed as a distinctive resort-style destination integrating natural scenery, comfortable accommodation, and conference facilities.

Its peaceful environment and convenient transportation make it an ideal venue for WAI 2026 participants.



LOCATION MAP AROUND THE CONFERENCE VENUE



★ Hangzhou Blossom Water Museum Hotel

Address: No.118 Shuibo Road, Xiaoshan District, Hangzhou, Zhejiang, China
(+86-571-83500888)

Website: <https://www.hangzhoublossomwater.cn/>



REGISTRATION HOURS/FLOOR PLAN

Admission to all sessions and hosted functions requires the attendance identification. Please wear your name badge at all times.

Registration time

- | | |
|--|---------------|
| ☐ November 3, Tuesday | 14:00 - 19:00 |
| ☐ November 4, Wednesday | 7:30 – 9:00 |

Registration Address

Hangzhou Blossom Water Museum Hotel
No.118 Shuibo Road, Xiaoshan District, Hangzhou, Zhejiang, China



PROGRAM OVERVIEW

Symposium Web: <https://wai-emc.com/wai2026/>

Symposium Hours

November 4, 2026, 8:30 – 17:30

November 5, 2026, 8:40 – 17:30

November 6, 2026, 8:40 – 12:00

November 4 – Wednesday

- ☐ Official Opening and Keynote Speeches
- ☐ Industry Plenary
- ☐ Technical Exhibition

November 5 – Thursday

- ☐ Industry Plenary
- ☐ Oral Sessions
- ☐ Best Student Paper Competition
- ☐ Poster Discussion
- ☐ Technical Exhibition
- ☐ Award Ceremony

November 6 – Friday

- ☐ Oral Sessions
- ☐ Technical Exhibition

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Date	Time	Agenda
Nov. 4th	08:30-09:00	Opening Ceremony
	09:00-12:00	Keynote Speeches
	12:00-13:40	Lunch (Buffet)
	14:00-15:30	Industry Plenary
	15:30-15:50	Tea Break
	15:50-17:30	Industry Plenary
	18:30	Dinner (Buffet)

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Date	Time	Room #1	Room #2	Room #3	Room #4	Room #5 (ZJUI at Haining)
Nov. 5th	8:40-10:20	Industry Plenary	Special Session	Special Session	Best Student Paper Competition	
	10:20-10:40	Tea Break				
	10:40-12:00	Industry Plenary	Special Session	Special Session	Best Student Paper Competition	
	12:00-13:30	Lunch (Buffet) & Rest				
		Room #1	Room #2	Room #3	Room #4	Room #5 (ZJUI at Haining)
	13:30-15:10	Special Session	Special Session	Special Session	Poster Discussion	Special Session
	15:10-15:30	Tea Break				
	15:30-17:30	Special Session	Special Session	Special Session	Poster Discussion	Special Session
	18:30	Banquet Dinner & Award Ceremony				
Nov. 6th		Room #1	Room #2	Room #3	Room #4	Room #5 (ZJUI at Haining)
	8:40-10:20	Special Session	Special Session	Special Session	Special Session	
	10:20-10:40	Tea Break				
	10:40-12:00	Special Session	Special Session	Special Session	Special Session	
	END					



Welcome to Join WAI with us!



Scan the Code to View the
Conference Official Website

<https://www.wai-emc.com/wai2026/>



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